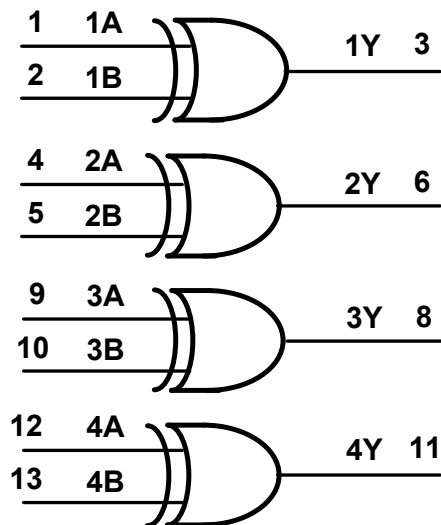


## Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1B	Data Input
3	1Y	Data Output
4	2A	Data Input
5	2B	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3B	Data Input
11	4Y	Data Output
12	4A	Data Input
13	4B	Data Input
14	V <sub>CC</sub>	Supply Voltage

## Logic Diagram



## Function Table

Inputs		Output
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

**Absolute Maximum Ratings** (Note 4) (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
$V_{CC}$	Supply Voltage Range	-0.5 to +7.0	V
$V_I$	Input Voltage Range (Note 5)	-0.5 to +7.0	V
$I_{IK}$	Input Clamp Current $V_I < -0.5\text{V}$ or $V_I > V_{CC} + 0.5\text{V}$	$\pm 20$	mA
$I_{OK}$	Output Clamp Current $V_O < -0.5\text{V}$ or $V_O > V_{CC} + 0.5\text{V}$	$\pm 20$	mA
$I_O$	Continuous Output Current $-0.5\text{V} < V_O < V_{CC} + 0.5\text{V}$	+/- 25	mA
$I_{CC}$	Continuous Current Through $V_{CC}$	50	mA
$I_{GND}$	Continuous Current Through GND	-50	mA
$T_J$	Operating Junction Temperature	-40 to +150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature	-65 to +150	$^\circ\text{C}$
$P_{TOT}$	Total Power Dissipation	500	mW

Notes: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

5. Input Voltage cannot exceed  $V_{CC}$  to the extent the maximum clamp current is exceeded.

**Recommended Operating Conditions** (Note 6) (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	Supply Voltage		4.5	5.5	V
$V_I$	Input Voltage		0	$V_{CC}$	V
$V_O$	Output Voltage		0	$V_{CC}$	V
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate	$V_{CC} = 4.5\text{V}$ to $5.5\text{V}$		500	ns/V
$T_A$	Operating Free-Air Temperature		-40	+125	$^\circ\text{C}$

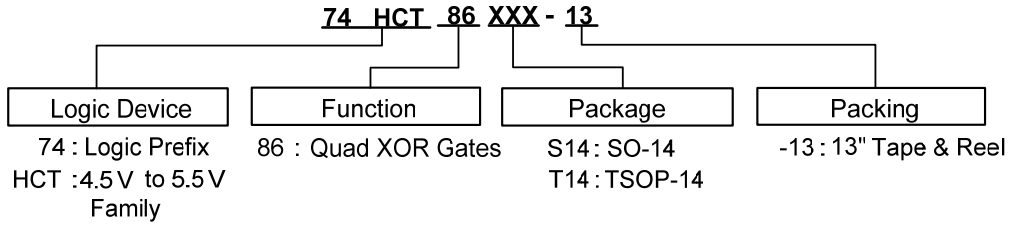
Note: 6. Unused inputs should be held at  $V_{CC}$  or Ground.

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Test Conditions	$V_{CC}$	$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$		$T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$		Unit
				Min	Max	Min	Max	
$V_{IH}$	High-level Input Voltage		4.5V to 5.5V	2.0	—	2.0	—	V
$V_{IL}$	Low-level Input Voltage		4.5V to 5.5V	—	0.8	—	0.8	V
$V_{OH}$	High-level Output Voltage	$I_{OH} = -20\mu\text{A}$	4.5V	4.4	—	4.4	—	V
		$I_{OH} = -4\text{mA}$	4.5V	3.84	—	3.70	—	
$V_{OL}$	Low-level Output Voltage	$I_{OL} = 20\mu\text{A}$	4.5V	—	0.1	—	0.1	V
		$I_{OL} = 4.0\text{mA}$	4.5V	—	0.33	—	0.4	
$I_I$	Input Current	$V_I = \text{GND}$ to $6.0\text{V}$	6.0V	—	$\pm 1$	—	$\pm 1$	$\mu\text{A}$
$I_{CC}$	Supply Current	$V_I = \text{GND}$ or $V_{CC}$ , $I_O = 0$	6.0V	—	20	—	40	$\mu\text{A}$
$\Delta I_{CC}$	Additional Supply Current	One Input at $V_{CC} - 2.1\text{V}$ Other Pins at $V_{CC}$ or GND	4.5V to 5.5V	—	675	—	735	$\mu\text{A}$



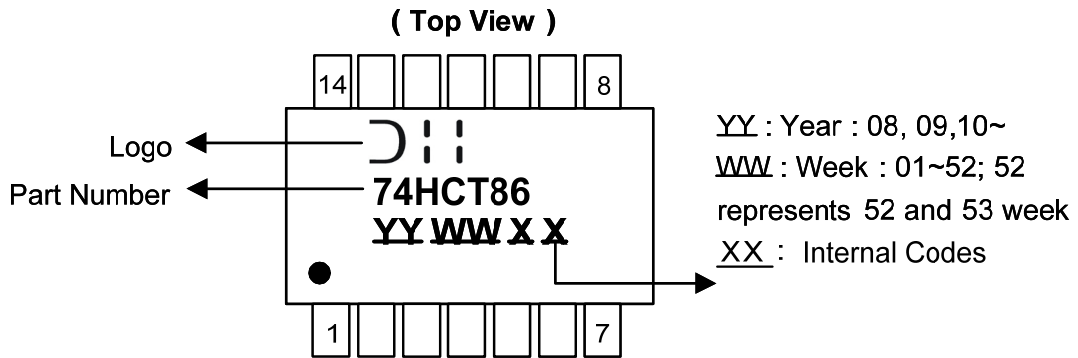
**Ordering Information**



Device	Package Code	Packaging	7" Tape and Reel	
			Quantity	Part Number Suffix
74HCT86S14-13	S14	SO-14	2500/Tape & Reel	-13
74HCT86T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

**Marking Information**

(1) SO-14, TSSOP-14

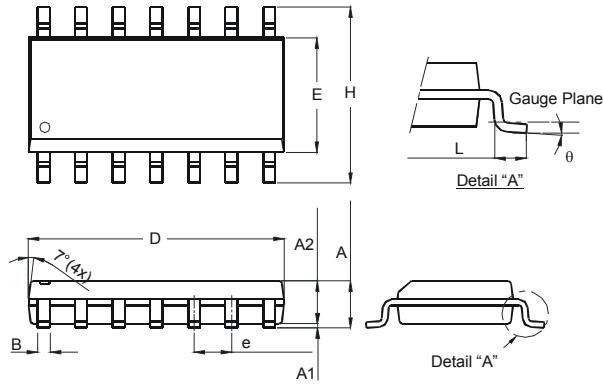


Part Number	Package
74HCT86S14	SO-14
74HCT86T14	TSSOP-14

**Package Outline Dimensions** (All dimensions in mm.)

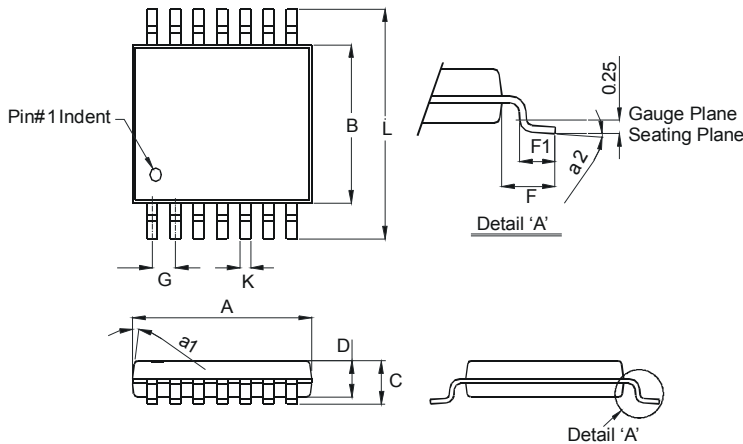
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

**Package Type: SO-14**



SO-14		
Dim	Min	Max
A	1.47	1.73
A1	0.10	0.25
A2	1.45 Typ	
B	0.33	0.51
D	8.53	8.74
E	3.80	3.99
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
θ	0°	8°
<b>All Dimensions in mm</b>		

**Package Type: TSSOP-14**

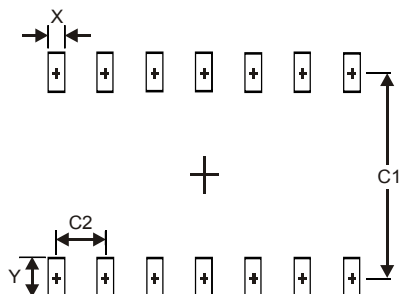


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
A	4.9	5.10
B	4.30	4.50
C	—	1.2
D	0.8	1.05
F	1.00 Typ	
F1	0.45	0.75
G	0.65 Typ	
K	0.19	0.30
L	6.40 Typ	
<b>All Dimensions in mm</b>		

## Suggested Pad Layout

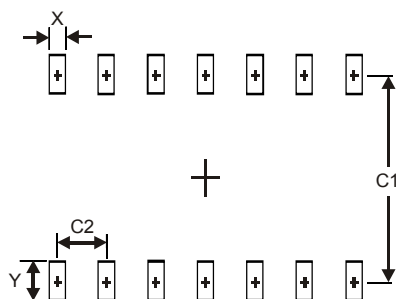
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.

**Package Type: SO-14**



Dimensions	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

**Package Type: TSSOP-14**



Dimensions	Value (in mm)
X	0.45
Y	1.45
C1	5.9
C2	0.65

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